

DATA SHEET

74LV138

3-to-8 line decoder/multiplexer; inverting

Product specification
Supersedes data of 1997 Feb 03
IC24 Data Handbook

1998 Apr 28

3-to-8 line decoder/demultiplexer; inverting

74LV138

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7$ V and $V_{CC} = 3.6$ V
- Typical V_{OLP} (output ground bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_{amb} = 25^{\circ}\text{C}$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_{amb} = 25^{\circ}\text{C}$
- Demultiplexing capability
- Multiple input enable for easy expansion
- Ideal for memory chip select decoding
- Active LOW mutually exclusive outputs
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV138 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC/HCT138.

The 74LV138 accepts three binary weighted address inputs (A_0 , A_1 , A_2) and when enabled, provide 8 mutually exclusive active LOW outputs ($\bar{Y}_0$ to $\bar{Y}_7$).

The 74LV138 features three enable inputs: two active LOW ($\bar{E}_1$, and $\bar{E}_2$) and one active HIGH (E_3). Every output will be HIGH unless $\bar{E}_1$ and $\bar{E}_2$ are LOW and E_3 is HIGH.

This multiple enable function allows easy parallel expansion of the 74LV138 to a 1-of-32 (5 lines to 32 lines) decoder with just four 74LV138 ICs and one inverter. The 74LV138 can be used as an eight output demultiplexer by using one of the active LOW enable inputs as the data input and the remaining enable inputs as strobes. Unused enable inputs must be permanently tied to their appropriate active HIGH or LOW state. The 74LV138 is identical to the 74LV238 but has non-inverting (true) outputs.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}\text{C}$; $t_r = t_f \leq 2.5$ ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay An to $\bar{Y}_n$, E3 to $\bar{Y}_n$, $\bar{E}_n$ to $\bar{Y}_n$	$C_L = 15$ pF; $V_{CC} = 3.3$ V	12 14	ns ns
C_i	Input capacitance		3.5	pF
C_{PD}	Power dissipation capacitance per package	$V_{CC} = 3.3$ V $V_i = \text{GND to } V_{CC}^1$	45	pF

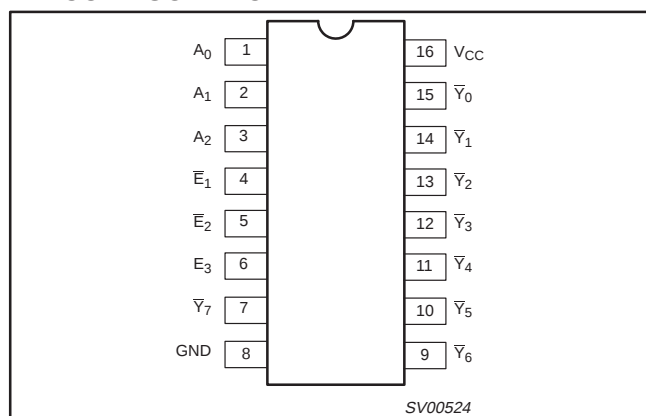
NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacitance in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	-40°C to $+125^{\circ}\text{C}$	74LV138 N	74LV138 N	SOT38-4
16-Pin Plastic SO	-40°C to $+125^{\circ}\text{C}$	74LV138 D	74LV138 D	SOT109-1
16-Pin Plastic SSOP Type II	-40°C to $+125^{\circ}\text{C}$	74LV138 DB	74LV138 DB	SOT338-1
16-Pin Plastic TSSOP Type I	-40°C to $+125^{\circ}\text{C}$	74LV138 PW	74LV138PW DH	SOT403-1

PIN CONFIGURATION



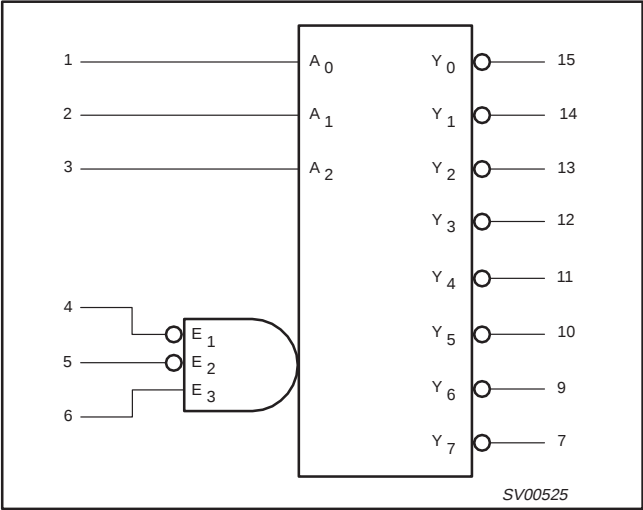
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1, 2, 3	A_0 to A_2	Address inputs
4, 5	$\bar{E}_1$ to $\bar{E}_2$	Enable inputs (active LOW)
6	E_3	Enable inputs (active HIGH)
15, 14, 13, 12, 11, 10, 9, 7	$\bar{Y}_0$ to $\bar{Y}_7$	Outputs
8	GND	Ground (0 V)
16	V_{CC}	Positive supply voltage

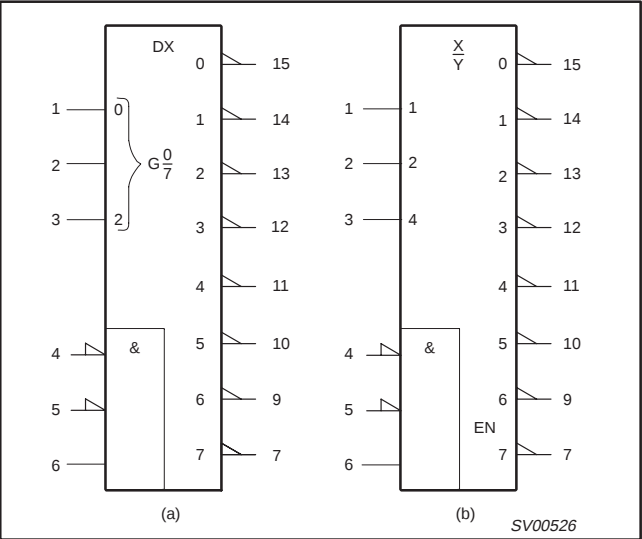
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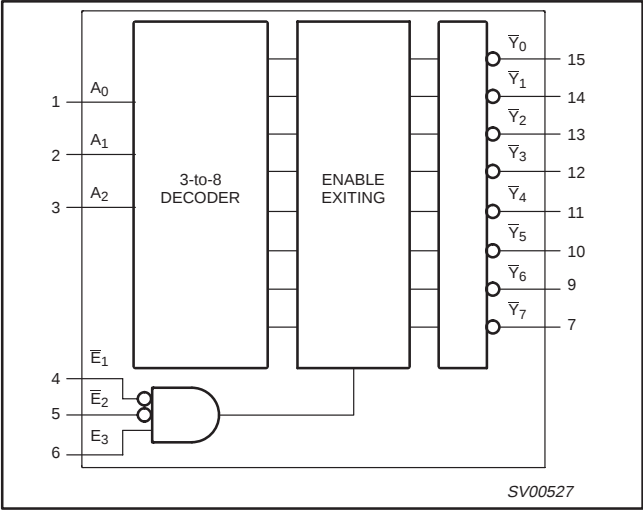
LOGIC DIAGRAM



LOGIC SYMBOL (IEEE/IEC)



FUNCTIONAL DIAGRAM



FUNCTION TABLE

INPUTS						OUTPUTS							
$\bar{E}_1$	$\bar{E}_2$	E_3	A_0	A_1	A_2	$\bar{Y}_0$	$\bar{Y}_1$	$\bar{Y}_2$	$\bar{Y}_3$	$\bar{Y}_4$	$\bar{Y}_5$	$\bar{Y}_6$	$\bar{Y}_7$
H	X	X	X	X	X	H	H	H	H	H	H	H	H
X	H	X	X	X	X	H	H	H	H	H	H	H	H
X	X	L	X	X	X	H	H	H	H	H	H	H	H
L	L	H	L	L	L	L	H	H	H	H	H	H	H
L	L	H	H	L	L	H	L	H	H	H	H	H	H
L	L	H	L	H	L	H	H	L	H	H	H	H	H
L	L	H	H	H	L	H	H	H	L	H	H	H	H
L	L	H	L	L	H	H	H	H	H	L	H	H	H
L	L	H	H	L	H	H	H	H	H	H	L	H	H
L	L	H	L	H	H	H	H	H	H	H	H	L	H
L	L	H	H	H	H	H	H	H	H	H	H	H	L

NOTES:
H = HIGH voltage level
L = LOW voltage level
X = don't care

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	DC supply voltage	See Note 1	1.0	3.3	5.5	V
V_I	Input voltage		0	–	V_{CC}	V
V_O	Output voltage		0	–	V_{CC}	V
T_{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	–40 –40		+85 +125	°C
t_r, t_f	Input rise and fall times	$V_{CC} = 1.0V$ to $2.0V$ $V_{CC} = 2.0V$ to $2.7V$ $V_{CC} = 2.7V$ to $3.6V$ $V_{CC} = 3.6V$ to $5.5V$	– – – –	– – – –	500 200 100 50	ns/V

NOTE:

1. The LV is guaranteed to function down to $V_{CC} = 1.0V$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2V$ to $V_{CC} = 5.5V$.

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		–0.5 to +7.0	V
$\pm I_{IK}$	DC input diode current	$V_I < -0.5$ or $V_I > V_{CC} + 0.5V$	20	mA
$\pm I_{OK}$	DC output diode current	$V_O < -0.5$ or $V_O > V_{CC} + 0.5V$	50	mA
$\pm I_O$	DC output source or sink current – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
$\pm I_{GND},$ $\pm I_{CC}$	DC V_{CC} or GND current for types with – standard outputs		50	mA
T_{stg}	Storage temperature range		–65 to +150	°C
P_{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: –40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40°C to +85°C			-40°C to +125°C		
			MIN	TYP ¹	MAX	MIN	MAX	
V _{IH}	HIGH level Input voltage	V _{CC} = 1.2 V	0.9			0.9		V
		V _{CC} = 2.0 V	1.4			1.4		
		V _{CC} = 2.7 to 3.6 V	2.0			2.0		
		V _{CC} = 4.5 to 5.5 V	0.7 * V _{CC}			0.7 * V _{CC}		
V _{IL}	LOW level Input voltage	V _{CC} = 1.2 V			0.3		0.3	V
		V _{CC} = 2.0 V			0.6		0.6	
		V _{CC} = 2.7 to 3.6 V			0.8		0.8	
		V _{CC} = 4.5 to 5.5			0.3 * V _{CC}		0.3 * V _{CC}	
V _{OH}	HIGH level output voltage; all outputs	V _{CC} = 1.2 V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA		1.2				V
		V _{CC} = 2.0 V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA	1.8	2.0		1.8		
		V _{CC} = 2.7 V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA	2.5	2.7		2.5		
		V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA	2.8	3.0		2.8		
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA	4.3	4.5		4.3		
V _{OH}	HIGH level output voltage; STANDARD outputs	V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; -I _O = 6mA	2.40	2.82		2.20		V
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; -I _O = 12mA	3.60	4.20		3.50		
V _{OL}	LOW level output voltage; all outputs	V _{CC} = 1.2 V; V _I = V _{IH} or V _{IL} ; I _O = 100μA		0				V
		V _{CC} = 2.0 V; V _I = V _{IH} or V _{IL} ; I _O = 100μA		0	0.2		0.2	
		V _{CC} = 2.7 V; V _I = V _{IH} or V _{IL} ; I _O = 100μA		0	0.2		0.2	
		V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; I _O = 100μA		0	0.2		0.2	
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; I _O = 100μA		0	0.2		0.2	
V _{OL}	LOW level output voltage; STANDARD outputs	V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; I _O = 6mA		0.25	0.40		0.50	V
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; I _O = 12mA		0.35	0.55		0.65	
I _I	Input leakage current	V _{CC} = 5.5 V; V _I = V _{CC} or GND			1.0		1.0	μA
I _{CC}	Quiescent supply current; MSI	V _{CC} = 5.5 V; V _I = V _{CC} or GND; I _O = 0			20.0		160	μA
ΔI _{CC}	Additional quiescent supply current per input	V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V			500		850	μA

NOTE:

1. All typical values are measured at $T_{amb} = 25^\circ\text{C}$.

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AC CHARACTERISTICS

GND = 0V; $t_r = t_f = 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				−40 to +85 °C			−40 to +125 °C		
				V _{CC} (V)	MIN	TYP ¹	MAX	MIN	
t _{PHL} /t _{PLH}	Propagation delay A _n to $\bar{Y}_n$	Figures 1, 3	1.2		75				ns
			2.0		26	44		55	
			2.7		19	31		39	
			3.0 to 3.6		15 ²	26		32	
			4.5 to 5.5		— ³	17		22	
t _{PHL} /t _{PLH}	Propagation delay E ₃ to $\bar{Y}_n$	Figures 1, 3	1.2		75				ns
			2.0		26	43		53	
			2.7		19	30		38	
			3.0 to 3.6		15 ²	25		31	
			4.5 to 5.5			19		24	
t _{PHL} /t _{PLH}	Propagation delay E _n to $\bar{Y}_n$	Figures 2, 3	1.2		75				ns
			2.0		26	43		53	
			2.7		19	30		38	
			3.0 to 3.6		15 ²	25		31	
			4.5 to 5.5			19		24	

- NOTES:
- 1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^\circ\text{C}$
 - 2. Typical values are measured at $V_{CC} = 3.3\text{ V}$.
 - 3. Typical values are measured at $V_{CC} = 5.0\text{ V}$.

AC WAVEFORMS

$V_M = 1.5\text{ V}$ at $V_{CC} \geq 2.7\text{ V}$ and $\leq 3.6\text{ V}$;
 $V_M = 0.5\text{ V} \times V_{CC}$ at $V_{CC} < 2.7\text{ V}$ and $\geq 4.5\text{ V}$;
 V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

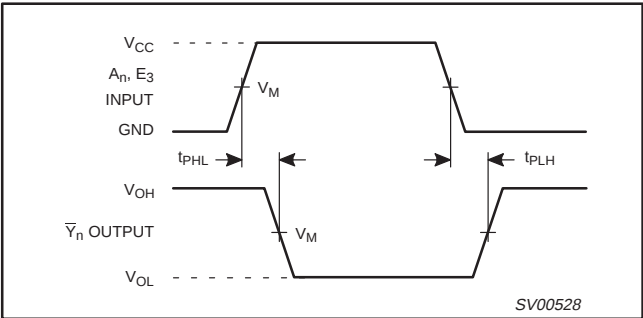


Figure 1. Input (A_n) and enable input (E_3) to output ($\bar{Y}_n$) propagation delays.

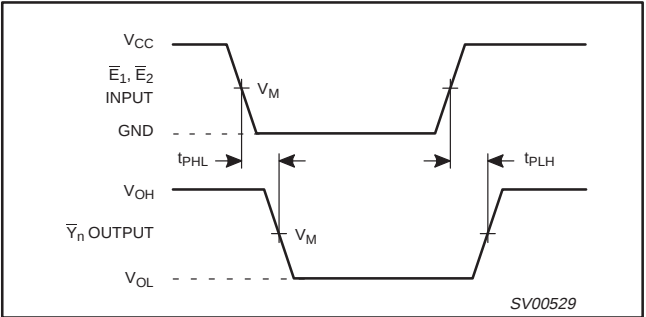


Figure 2. Enable input ($\bar{E}_n$) to output ($\bar{Y}_n$) propagation delays.

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TEST CIRCUIT

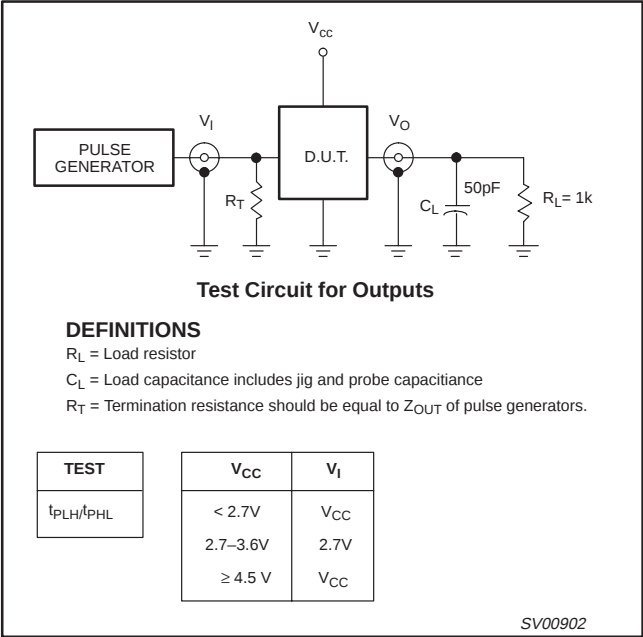


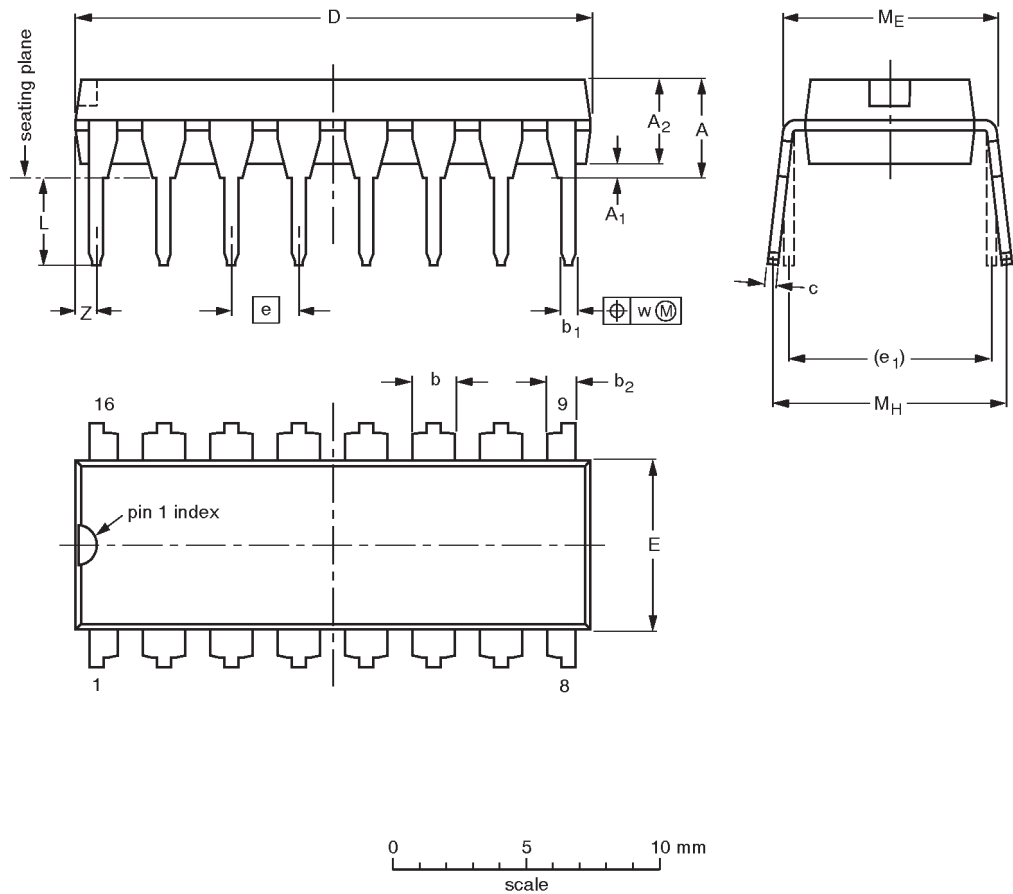
Figure 3. Load circuitry for switching times.

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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

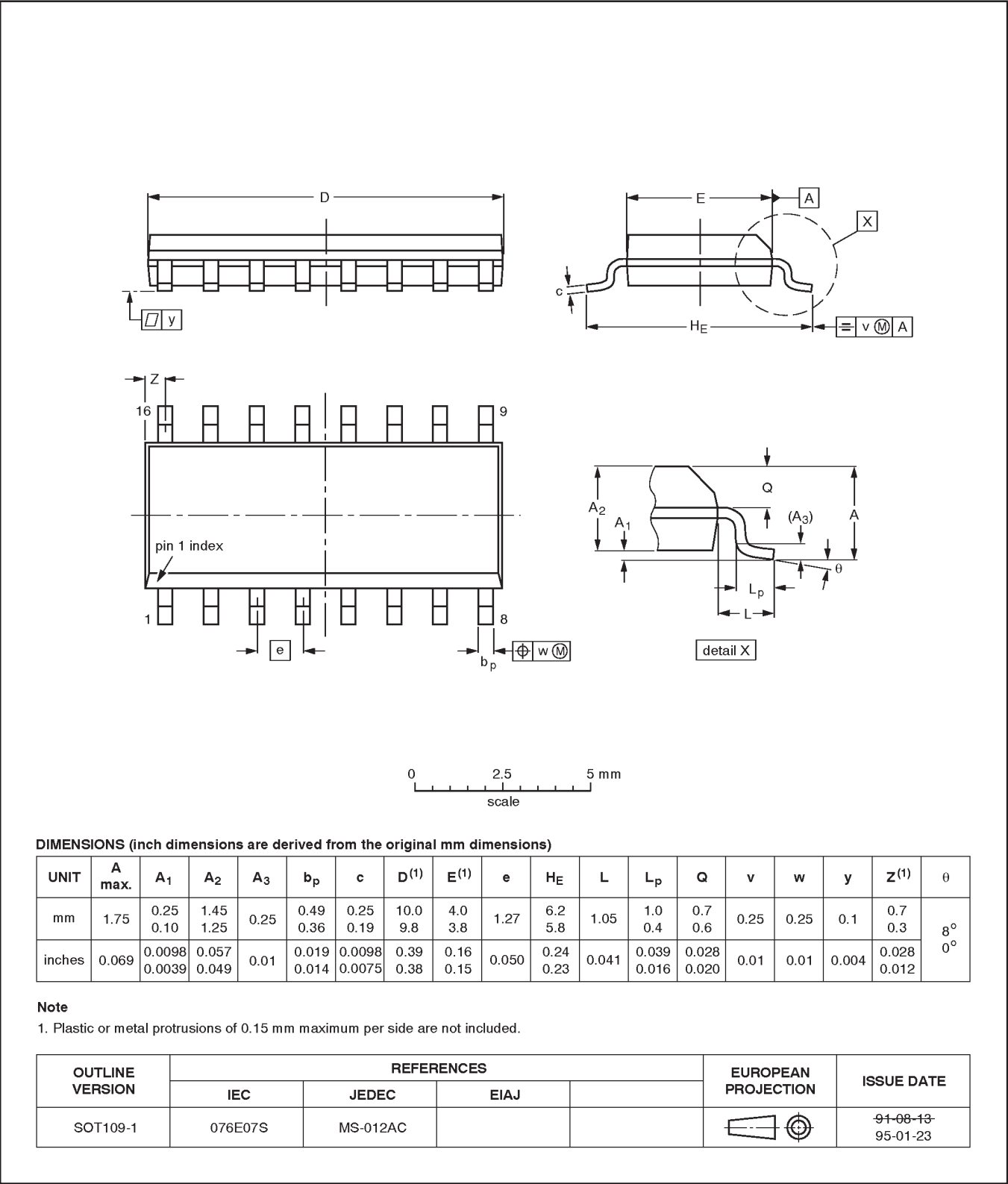
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						92-11-17 95-01-14

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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

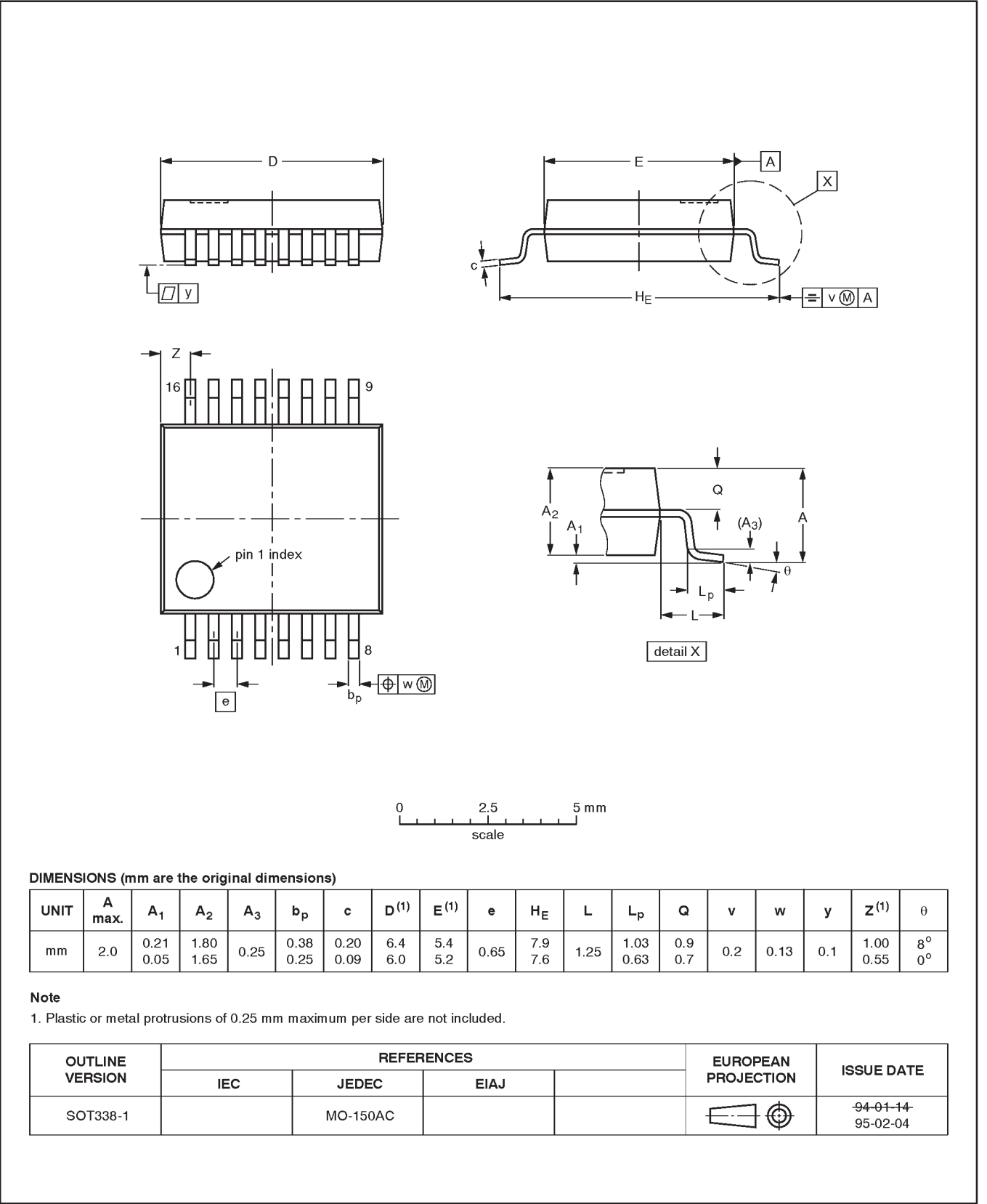


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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

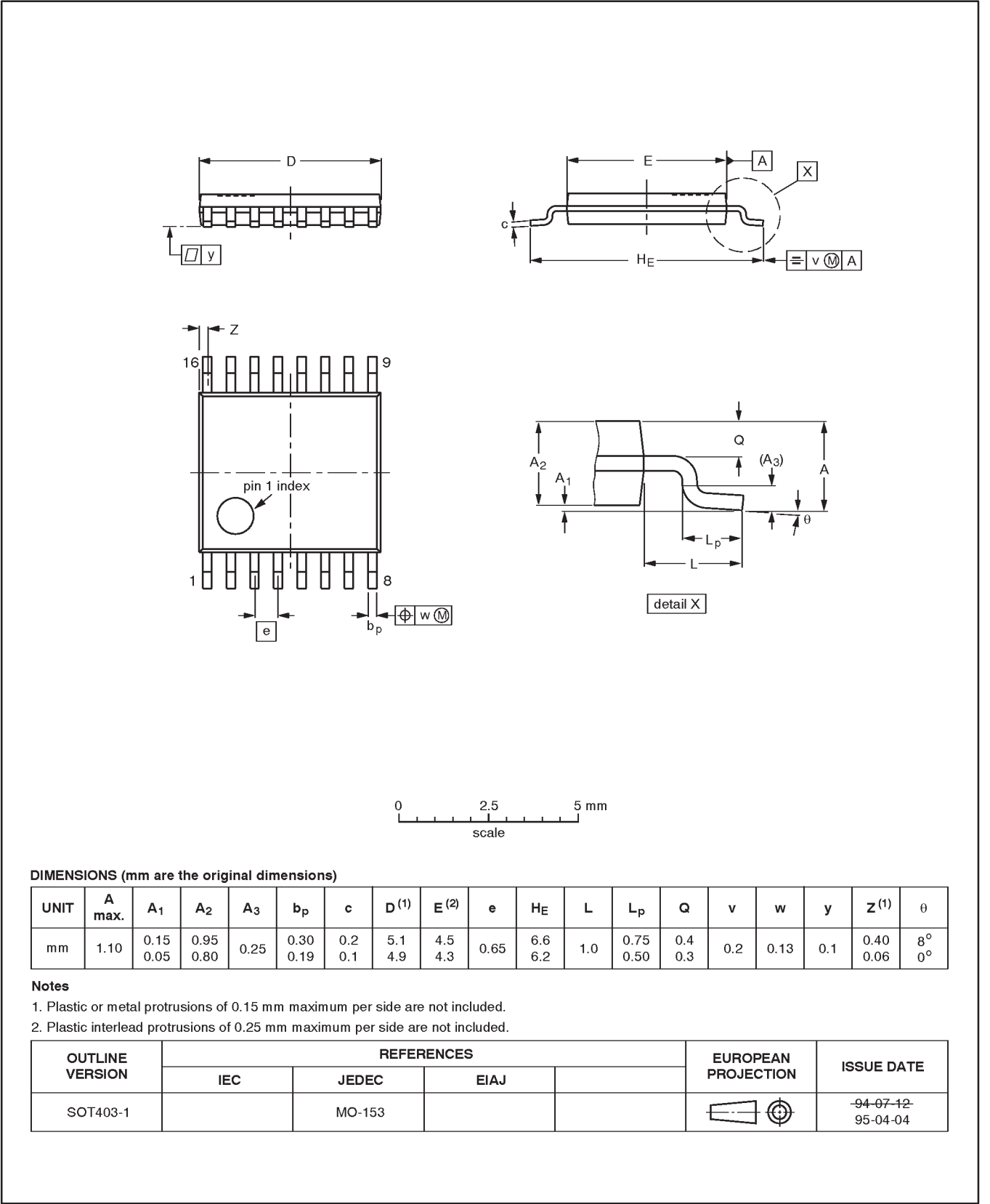


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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



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DEFINITIONS		
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
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